

ClockWorks™ Dual 10-Gigabit/Gigabit Ethernet 62.5MHz, 125MHz, or 156.25MHz, Ultra-Low Jitter LVCMOS Clock Frequency Synthesizer

General Description

The SM840002 is a dual 10-Gigabit Ethernet and Gigabit Ethernet, 62.5MHz, 125MHz, or 156.25MHz LVCMOS clock frequency synthesizer and a member of the ClockWorks[™] family of devices from Micrel. It provides a low-noise timing solution for high-speed, high-accuracy synthesis of clock signals. It includes a patented RotaryWave[®] architecture that provides a very stable clock with very-low noise.

Power supplies of either 2.5V or 3.3V are supported, with superior jitter and phase-noise performance. The device synthesizes a 62.5MHz, 125MHz, or 156.25MHz, low-noise LVCMOS output pair for Ethernet applications. The crystal reference frequency is 25MHz.

The SM840002 is an excellent replacement for IDT FemtoClocks[®], with improved waveform integrity, and jitter.

Data sheets and support documentation can be found on Micrel's web site at: <u>www.micrel.com</u>.

Features

- Generates two LVCMOS outputs
- Operating supply modes:
 - Core/Output
 - 3.3V/3.3V, 2.5V/2.5V
- Typical phase jitter @156.25MHz~64 fs (1.875MHz – 20MHz)
- Crystal frequency: 25MHz
- 62.5MHz, 125MHz, or 156.25MHz output frequency
- Output Skew: 12ps (maximum)
- Phase Noise @ 156.25MHz:
 - 1KHz: –126dBc/Hz
 - 10KHz: –130dBc/Hz
 - 100KHz: –126dBc/Hz
 - 1MHz: –139dBc/Hz
 - 10MHz: –165dBc/Hz
 - 20MHz: –166/dBc/Hz
- Temperature range: -40°C to +75°C
- Green-, RoHS-, and PFOS-compliant
- Available in 16-pin TSSOP

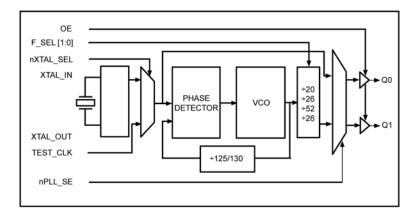
Applications

- Gigabit Ethernet
- 10-Gigabit Ethernet

ClockWorks is a trademark of Micrel, Inc. RotaryWave is a registered trademark of Multigig, Inc. FemtoClocks is a registered trademark of IDT, Inc.

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Block Diagram



Ordering Information⁽¹⁾

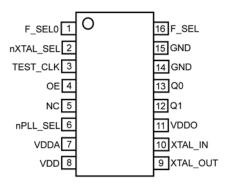
Part Number	Package Type	Operating Range	Package Marking
SM840002KA	K-16	–40°C to +75°C	840002
SM840002KA TR ⁽²⁾	K-16	–40°C to +75°C	840002

Notes:

1. Devices are Green-, RoHS-, and PFOS-compliant.

2. Tape and Reel.

Pin Configuration





Pin Description

Pin Number	Pin Name	Туре	Level	Pin Function
1	F_SEL0	I	Pull-Up	Frequency Select Pin. LVCMOS interface levels.
2	nXTAL_SEL	I	Pull-Down	Selects between XTAL and TEST_CLK Reference Input. When HIGH, selects TEST_CLK. When LOW, selects XTAL inputs. LVCMOS interface levels.
3	TEST_CLK	I	Pull-Down	Single-Ended LVCMOS Clock Input.
4	OE	I	Pull-Up	Output Enable. When HIGH, the outputs are active. When LOW, the outputs are in a high impedance state. LVCMOS interface levels.
5	NC			No Connect.
6	nPLL_SEL	I	Pull-Down	Selects between the VCO reference and the VCO Output. When LOW, the output is driven from the VCO output. When HIGH, the PLL is bypassed.
7	V _{DDA}	Р		2.5V or 3.3V Output Power Supply. No filter resistor needed.
8	V _{DD}	Р		2.5V or 3.3V Output Power Supply.
9	XTAL_OUT	0	12pF Crystal	Crystal Reference Output, no load caps needed.
10	XTAL_IN	I	12pF Crystal	Crystal Reference Input, no load caps needed.
11	V _{DDO}	Р		2.5V or 3.3V Output Power Supply.
12	Q1	0	LVCMOS	Single-Ended Output Clock.
13	Q0	0	LVCMOS	Single-Ended Output Clock.
14	GND	Р		Ground.
15	GND	Р		Ground.
16	F_SEL1	I	Pull-up	Frequency Select Pin. LVCMOS interface levels.

Configuring the SM840002

Xtal Frequency (MHz)	F_SEL1	F_SEL0	M Divider	N Divider	Output Frequency (MHz)
25	0	0	125	20	156.25
25	0	1	130	26	125
25	1	0	130	52	62.5
25	1	1	130	26	125

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V _{DD})	+4.6V
Input Voltage (V _{IN})	-0.50V to V _{DD} +0.5V
Output Voltage (V _{OUT})	-0.50V to V _{DD} +0.5V
Lead Temperature (soldering, 20sec.).	
Storage Temperature (T _s)	

Operating Ratings⁽²⁾

Supply Voltage (V _{DDO})	+2.375V to +3.465V
Supply Voltage (V _{DD} , V _{DDA})	+2.375V to +3.465V
Ambient Temperature (T _A)	40°C to +75°C
Junction Thermal Resistance	
TSSOP (θ _{JA})(Still Air)	127°C/W

DC Electrical Characteristics⁽³⁾

 $V_{DDA} = V_{DD} = 2.5V \pm 5\%$, $V_{DDO} = 2.5V \pm 5\%$, $T_A = -40^{\circ}C$ to +75°C, unless noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{DD}	Core Supply Voltage		2.375	2.50	2.625	V
V_{DDA}	Analog Supply Voltage		2.375	2.50	2.625	V
V _{DDO}	Output Supply Voltage		2.375	2.50	2.625	V
I _{DD}	Core Supply Current			0.1	1	mA
I _{DDA}	Analog Supply Current			48	55	mA
I _{DDO}	Output Supply Current	No Load		15	23	mA

 V_{DDA} = V_{DD} = 3.3V ±5%, V_{DDO} = 3.3V ±5%, T_{A} = –40°C to +75°C, unless noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{DD}	Core Supply Voltage		3.135	3.30	3.465	V
V _{DDA}	Analog Supply Voltage		3.135	3.30	3.465	V
V _{DDO}	Output Supply Voltage		3.135	3.30	3.465	V
I _{DD}	Core Supply Current			0.1	1	
I _{DDA}	Analog Supply Current			49	55	mA
I _{DDO}	Power Supply Current	No Load		25	32	mA

Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

3. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

LVCMOS DC Electrical Characteristics⁽³⁾

 V_{DDA} = V_{DD} =2.5V or 3.3V ±5%, V_{DDO} = 2.5V or 3.3V ±5%, T_A = -40°C to +75°C, unless noted.

Symbol	Parameter		Condition	Min.	Тур.	Max.	Units
V _{IH}	Input HIGH Voltage		out HIGH Voltage	2	2	V _{DD} + 0.3	V
VIL	Input LOW Voltage			-0.30		0.80	V
		OE, F_SEL0, F_SEL1	V _{DD} = V _{IN} =3.465V or 2.625V			5	μA
I _{IH}	Input HIGH Current	nPLL_SEL, MR, nXTAL_SEL, TEST_CLK	V _{DD} = V _{IN} =3.465V or 2.625V			150	μA
		OE, F_SEL0, F_SEL1	V _{DD} = 3.465V or 2.625V V _{IN} = 0V	-150			μA
l _{IL}	Input LOW Current	nPLL_SEL, MR, nXTAL_SEL, TEST_CLK	V _{DD} = 3.465V or 2.625V V _{IN} = 0V	-5			μA
M	Output HIGH Voltage	$V_{DDO} = 3.3V \pm 5\%$	V _{DDO} = 3.3V ±5%	2.6			V
V _{OH}			V _{DDO} = 2.5V ±5%	1.8			V
V _{OL}	Output LOW Voltage	4)	V _{DDO} = 3.3V ±5% or 2.5V ±5%			0.5	V

AC Electrical Characteristics⁽⁵⁾

 $V_{DDA} = V_{DD} = 2.5V \text{ or } 3.3V \pm 5\%, V_{DDO} = 2.5V \text{ or } 3.3V \pm 5\%, T_A = -40^{\circ}C \text{ to } +75^{\circ}C, \text{ unless noted.}$

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
Fout	Output Frequency	F_SEL[1:0] = 00		156.25		MHz
Fout	Output Frequency	F_SEL[1:0] = 01		125		MHz
Fout	Output Frequency	F_SEL[1:0] = 10		62.5		MHz
Fout	Output Frequency	F_SEL[1:0] = 11		125		MHz
t _{skew}	Output Skew ⁽⁶⁾				12	ps
t _{JITTER}	RMS Phase Jitter	156.25MHz		0.064		ps
t _{JITTER}	RMS Phase Jitter	125MHz		0.065		ps
t JITTER	RMS Phase Jitter	62.5MHz		0.077		ps
t _R /t _F	Output Rise/ Fall Time	20% to 80%	100		350	ps
O _{DC}	Output Duty Cycle		48	50	52	%

Notes:

4. Outputs terminated with 50 Ω to V_{DD}/2. See Parameters measurements 3.3V load test circuit.

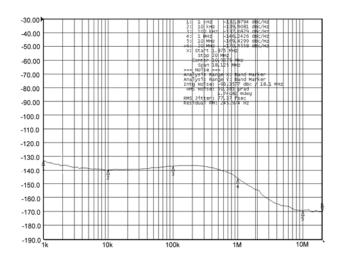
5. The circuit is designed to meet the AC specifications shown in the above table(s) after thermal equilibrium has been established.

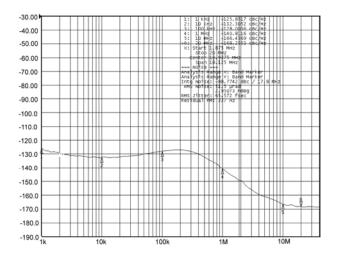
6. Defined as skew between outputs at the same supply voltage and with equal load conditions; Measured at the output differential crossing points.

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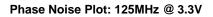
Crystal Characteristics

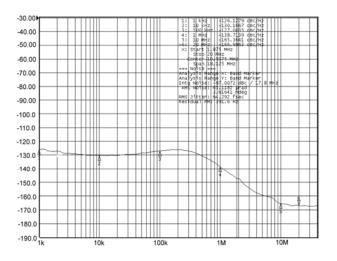
Parameter	Condition	Min.	Тур.	Max.	Units
Mode of Oscillation	12pF Load		Fundamental, Pa	rallel Resonant	
Frequency			25		MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitor, C0			3	7	pF
Correlation Drive Level			100	300	uW





Phase Noise Plot: 62.5MHz @ 3.3V





Phase Noise Plot: 156.25MHz @ 3.3V

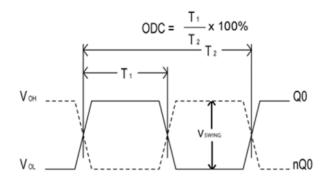


Figure 1. Duty Cycle Timing

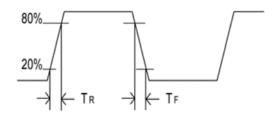
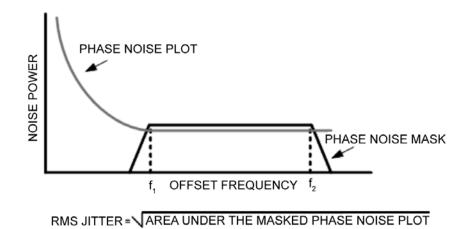
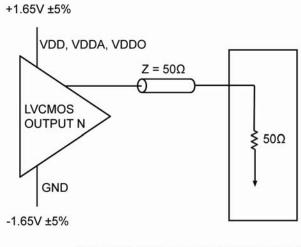


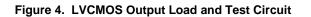
Figure 2. All Outputs Rise/Fall Time

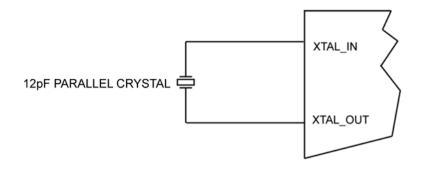






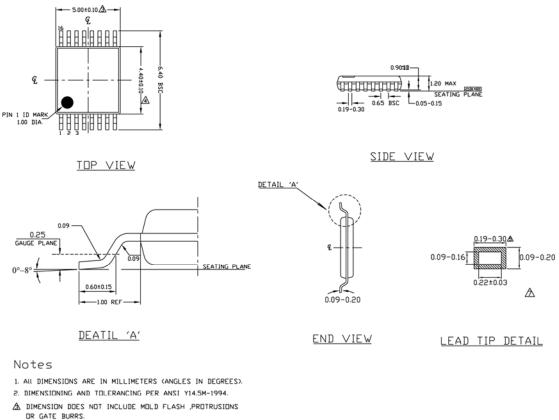
(OUTPUT LOAD AC TEST CIRCUIT, 3.3V)







Package Information



- A DIMENSION DOES NOT INCLUDE INTERNAL FLASH OR PROTRUSION.
- ▲ DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
- ▲ CROSS SECTION TO BE DETERMINED AT 0.10 TO 0.25MM FROM THE LEAD TIP.

16-Pin TSSOP (K-16)

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